



**THE DATASHEET OF  
PTFA080551F-V4-R250**





PTFA080551E  
PTFA080551F  
*green*  
Product

## Thermally-Enhanced High Power RF LDMOS FETs 55 W, 869 – 960 MHz

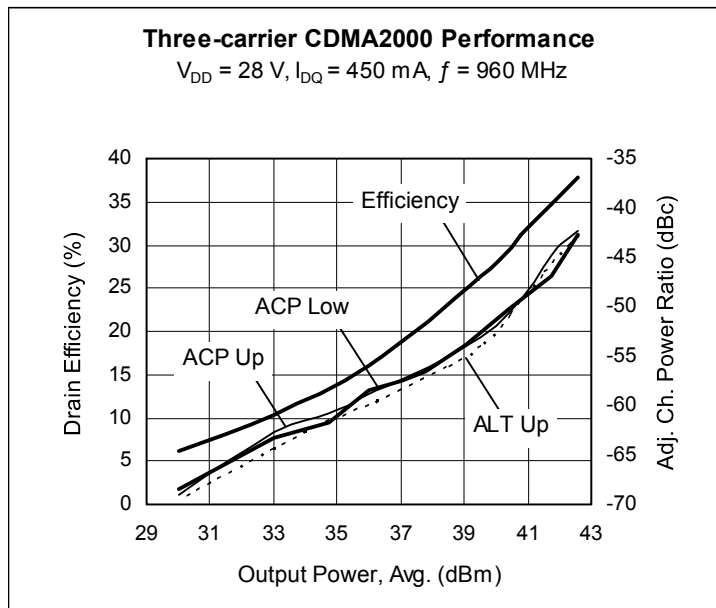
### Description

The PTFA080551E and PTFA080551F are 55-watt LDMOS FETs designed for EDGE and CDMA power amplifier applications in the 869 to 960 MHz band. Features include input matching and thermally-enhanced packages with slotted or earless flanges. Manufactured with Infineon's advanced LDMOS process, these devices provide excellent thermal performance and superior reliability.

PTFA080551E  
Package H-36265-2



PTFA080551F  
Package H-37265-2



### Features

- Broadband internal matching
- Typical EDGE performance
  - Average output power = 26 W
  - Gain = 18 dB
  - Efficiency = 44%
- Typical CW performance
  - Output power at P-1dB = 75 W
  - Gain = 17 dB
  - Efficiency = 67%
- Integrated ESD protection: Human Body Model, Class 2 (minimum)
- Excellent thermal stability, low HCI drift
- Capable of handling 10:1 VSWR @ 28 V, 55 W (CW) output power
- Pb-free and RoHS compliant

### RF Characteristics

**EDGE Measurements** (not subject to production test—verified by design/characterization in Infineon test fixture)

$V_{DD} = 28\text{ V}$ ,  $I_{DQ} = 450\text{ mA}$ ,  $P_{OUT} = 26\text{ W AVG}$ ,  $f = 959.8\text{ MHz}$

Characteristic	Symbol	Min	Typ	Max	Unit
Error Vector Magnitude	EVM (RMS)	—	2.5	—	%
Modulation Spectrum @ 400 kHz	ACPR	—	-60	—	dBc
Modulation Spectrum @ 600 kHz	ACPR	—	-75	—	dBc
Gain	$G_{ps}$	—	18	—	dB
Drain Efficiency	$\eta_D$	—	44	—	%

All published data at  $T_{CASE} = 25^\circ\text{C}$  unless otherwise indicated

**ESD:** Electrostatic discharge sensitive device—observe handling precautions!

**RF Characteristics** (cont.)

**Two-tone Measurements** (tested in Infineon test fixture)

 $V_{DD} = 28\text{ V}$ ,  $I_{DQ} = 600\text{ mA}$ ,  $P_{OUT} = 55\text{ W PEP}$ ,  $f = 960\text{ MHz}$ , tone spacing = 1 MHz

Characteristic	Symbol	Min	Typ	Max	Unit
Gain	$G_{ps}$	18	18.5	—	dB
Drain Efficiency	$\eta_D$	46.5	48	—	%
Intermodulation Distortion	IMD	—	-31	-29	dBc

**DC Characteristics**

Characteristic	Conditions	Symbol	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}$ , $I_{DS} = 10\text{ }\mu\text{A}$	$V_{(BR)DSS}$	65	—	—	V
Drain Leakage Current	$V_{DS} = 28\text{ V}$ , $V_{GS} = 0\text{ V}$	$I_{DSS}$	—	—	1.0	$\mu\text{A}$
	$V_{DS} = 63\text{ V}$ , $V_{GS} = 0\text{ V}$	$I_{DSS}$	—	—	10.0	$\mu\text{A}$
On-State Resistance	$V_{GS} = 10\text{ V}$ , $V_{DS} = 0.1\text{ V}$	$R_{DS(on)}$	—	0.15	—	$\Omega$
Operating Gate Voltage	$V_{DS} = 28\text{ V}$ , $I_{DQ} = 450\text{ mA}$	$V_{GS}$	2.0	2.3	3.0	V
Gate Leakage Current	$V_{GS} = 10\text{ V}$ , $V_{DS} = 0\text{ V}$	$I_{GSS}$	—	—	1.0	$\mu\text{A}$

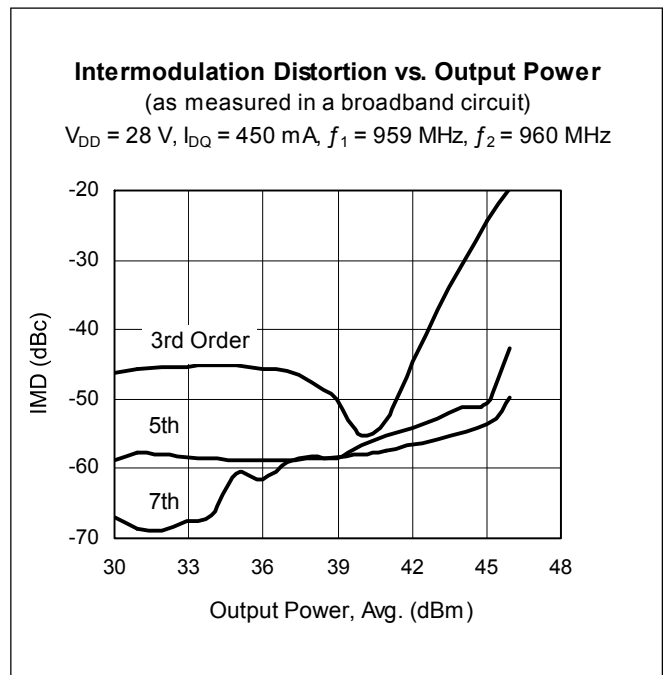
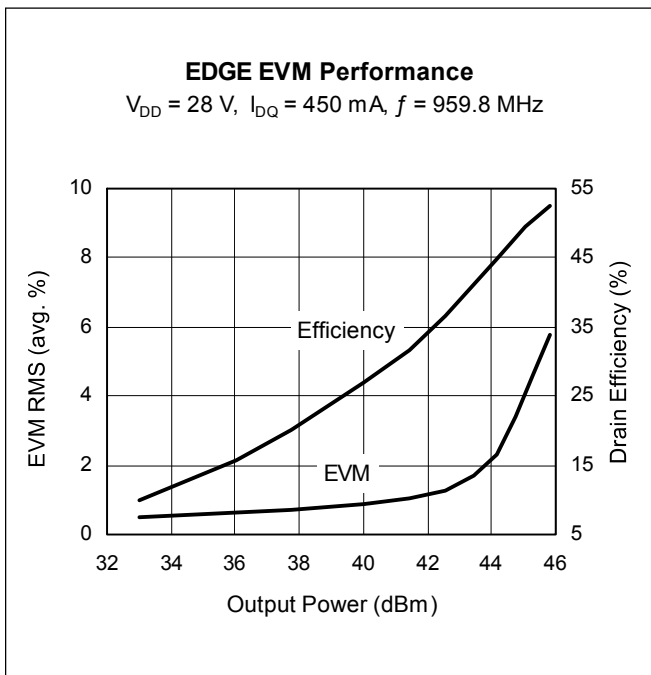
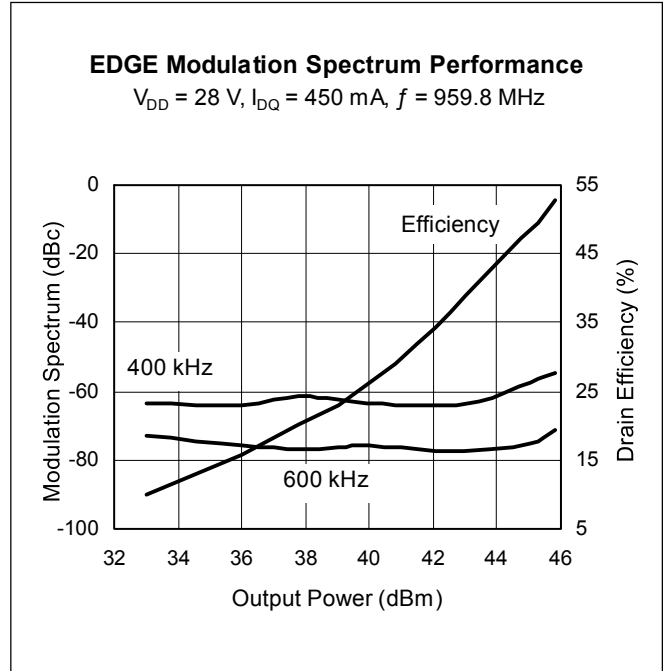
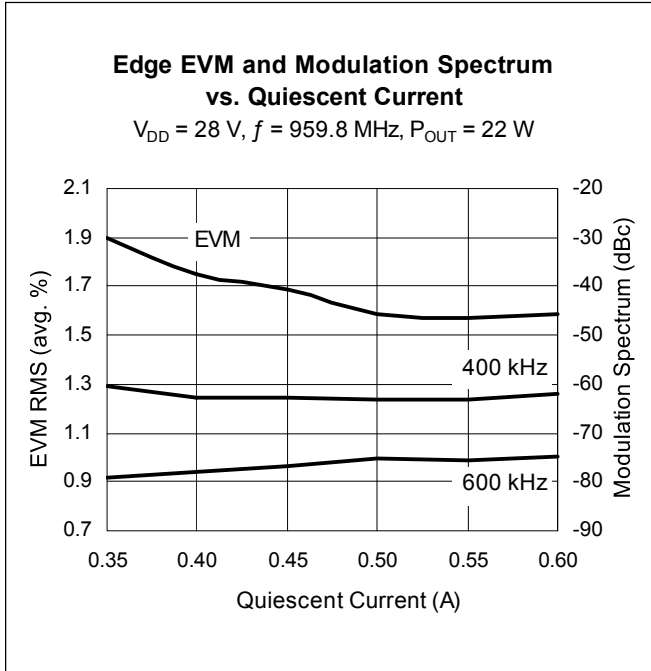
**Maximum Ratings**

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DSS}$	65	V
Gate-Source Voltage	$V_{GS}$	-0.5 to +12	V
Junction Temperature	$T_J$	200	$^{\circ}\text{C}$
Total Device Dissipation	$P_D$	219	W
		Above 25 $^{\circ}\text{C}$ derate by	1.25
Storage Temperature Range	$T_{STG}$	-40 to +150	$^{\circ}\text{C}$
Thermal Resistance ( $T_{CASE} = 70^{\circ}\text{C}$ )	$R_{\theta JC}$	0.8	$^{\circ}\text{C/W}$

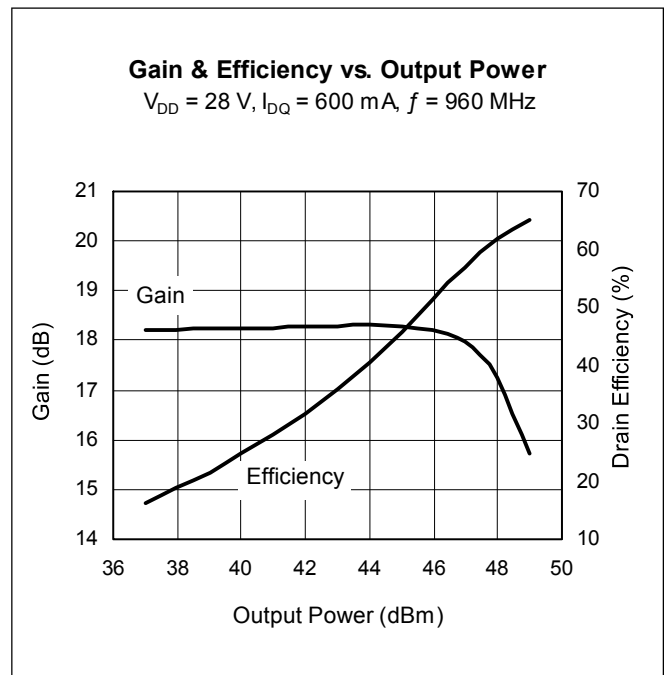
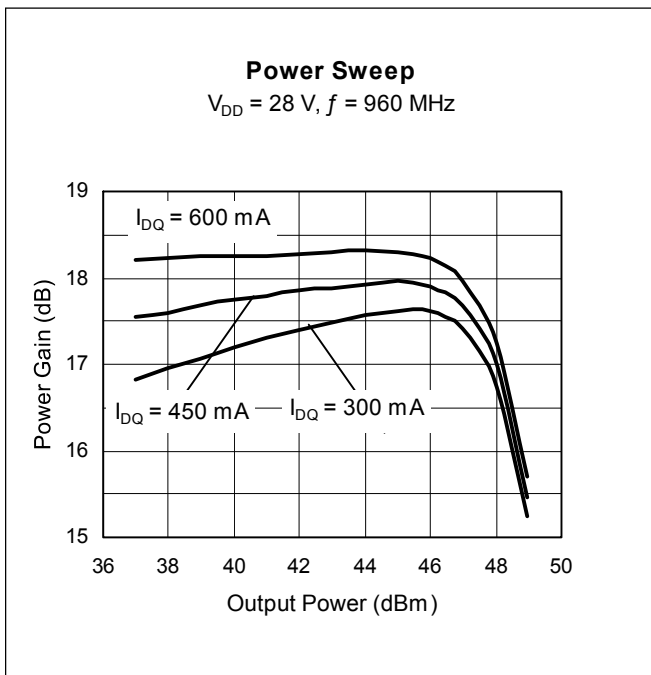
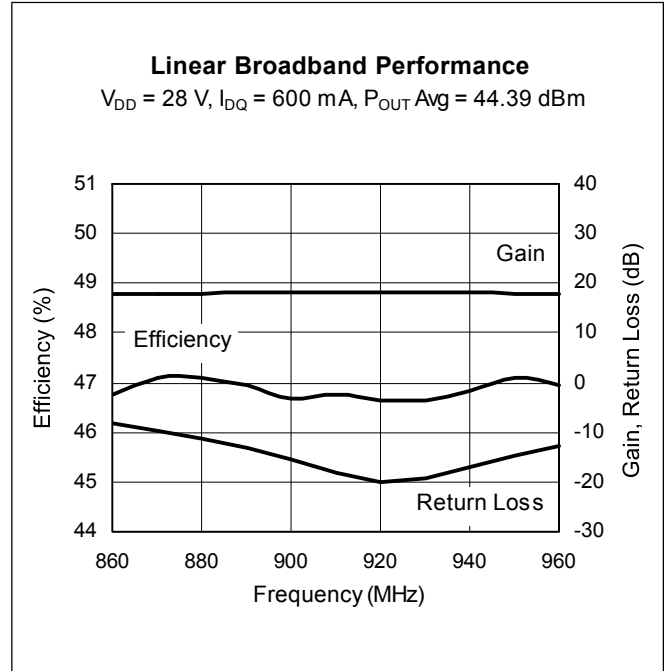
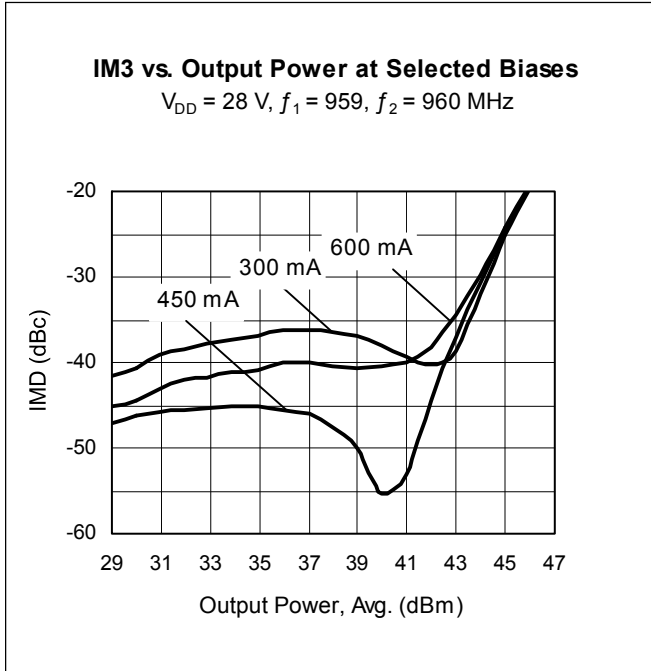
**Ordering Information**

Type and Version	Order Code	Package Description	Shipping
PTFA080551E V4 R0	PTFA080551EV4R0XTMA1	H-36265-2, bolt-down	Tape & Reel, 50 pcs
PTFA080551E V4 R250	PTFA080551EV4R250XTMA1	H-36265-2, bolt-down	Tape & Reel, 250 pcs
PTFA080551F V4 R0	PTFA080551FV4R0XTMA1	H-37265-2, earless flange	Tape & Reel, 50 pcs
PTFA080551F V4 R250	PTFA080551FV4R250XTMA1	H-37265-2, earless flange	Tape & Reel, 250 pcs

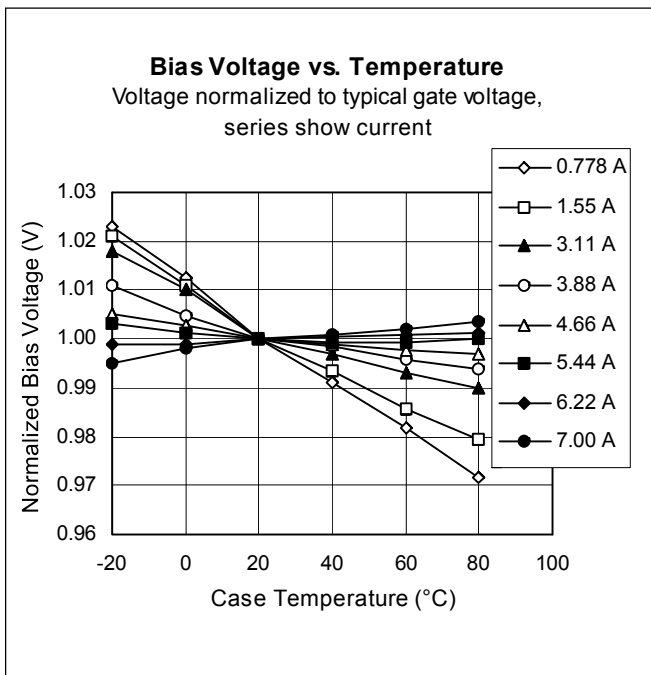
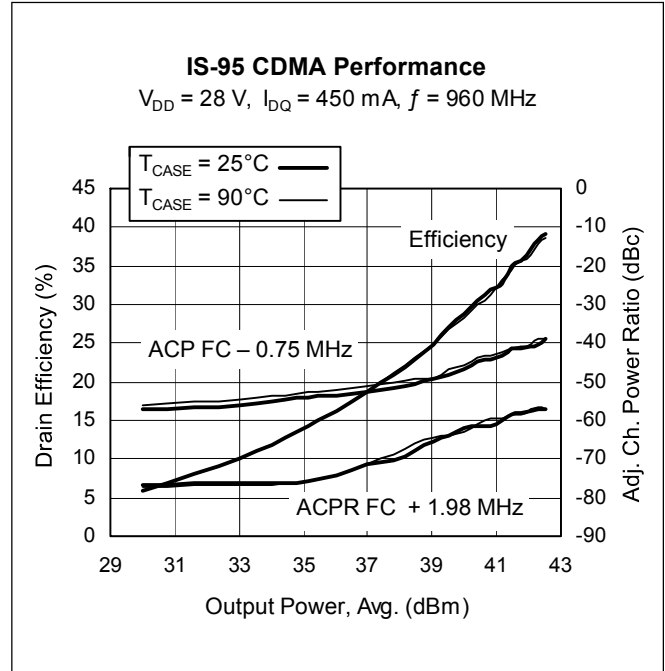
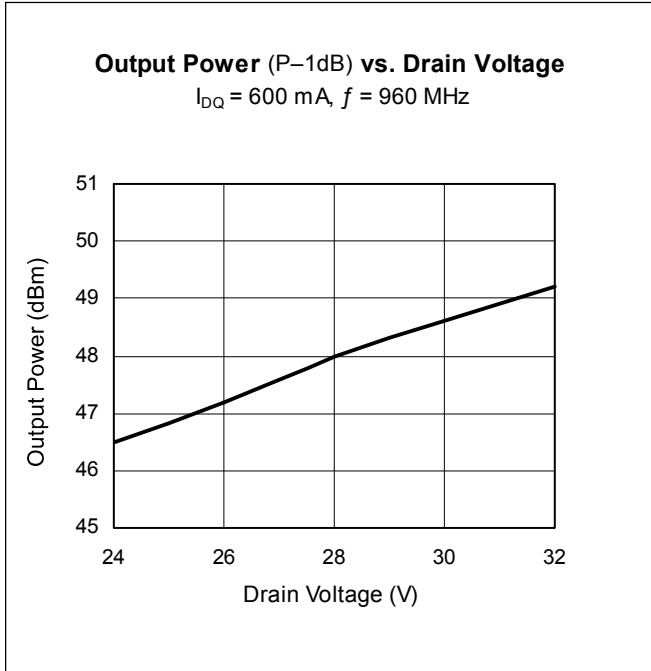
**Typical Performance** (data taken in a production test fixture)



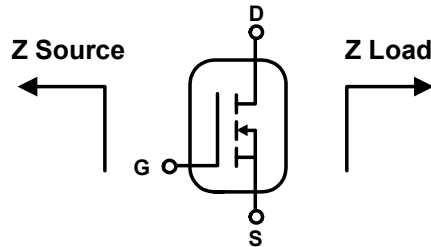
Typical Performance (cont.)



Typical Performance (cont.)



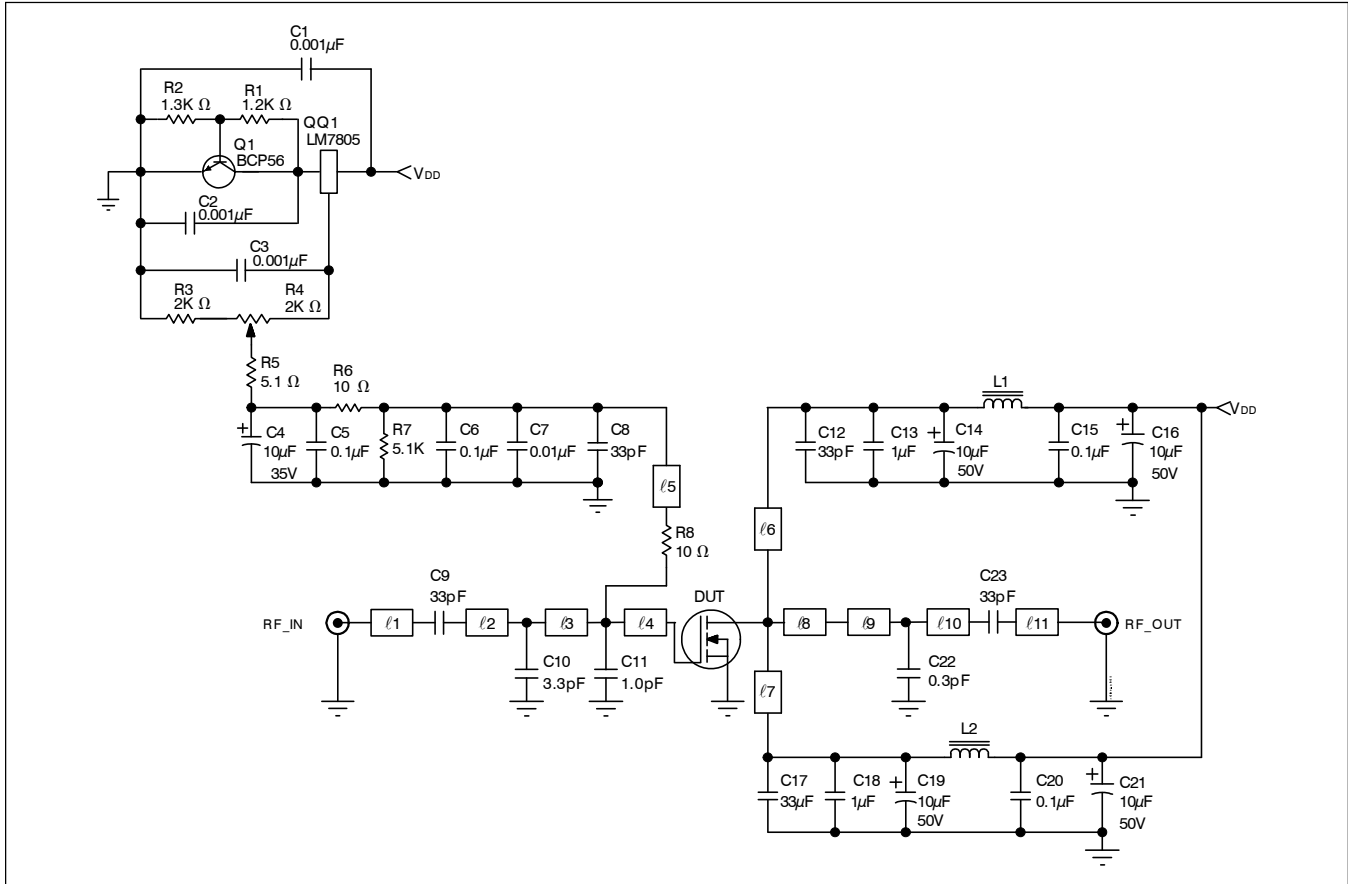
### Broadband Circuit Impedance



Frequency MHz	Z Source $\Omega$		Z Load $\Omega$	
	R	jX	R	jX
869	8.91	-10.93	7.42	-1.63
880	3.72	-8.28	4.65	-1.74
894	5.93	-5.43	4.61	0.16
920	4.87	-7.16	4.88	-0.59
960	6.05	-5.57	4.89	0.86

See next page for circuit information

## Reference Circuit



Reference circuit schematic diagram for  $f = 960 \text{ MHz}$

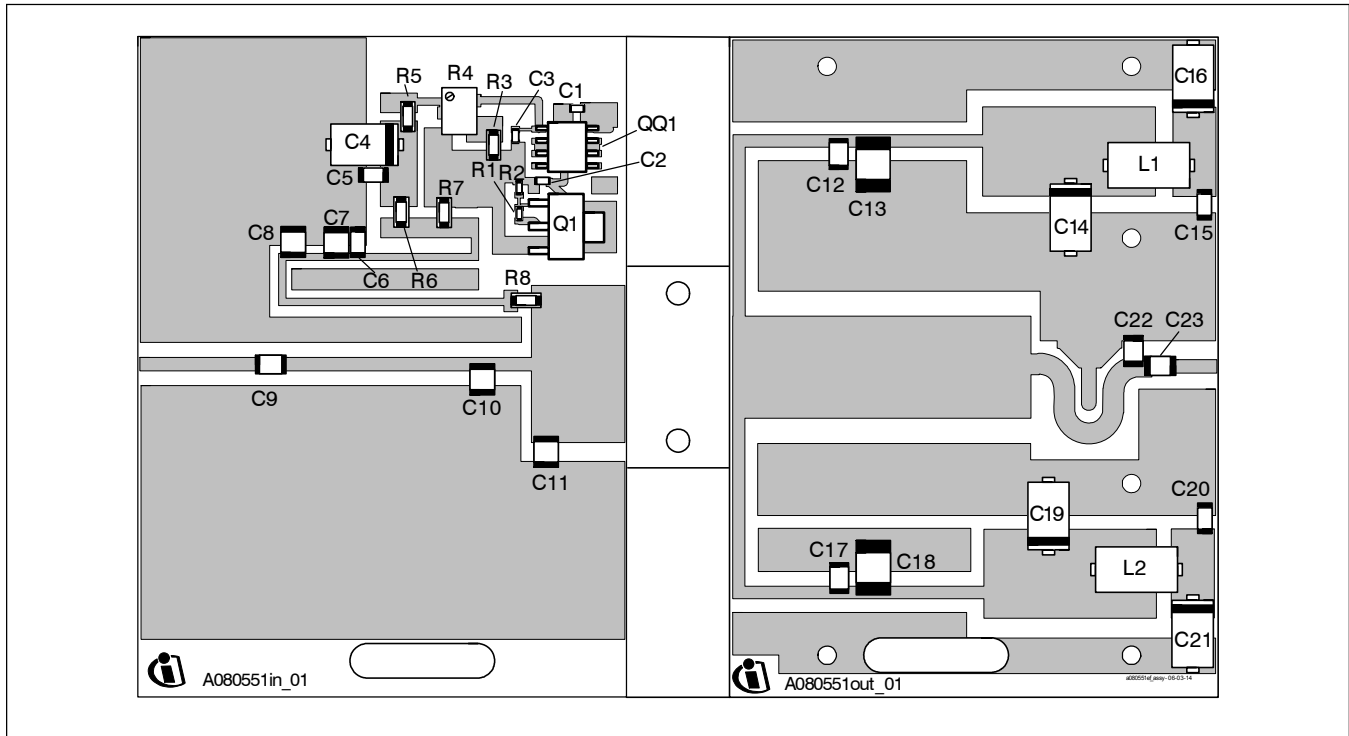
### Circuit Assembly Information

DUT	PTFA080551E or PTFA080551F	LDMOS Transistor	
PCB	0.76 mm [.030"] thick, $\epsilon_r = 4.5$	Rogers TMM4	2 oz. copper

Microstrip	Electrical Characteristics at 960 MHz <sup>1</sup>	Dimensions: L x W (mm)	Dimensions: L x W (in.)
$l_1$	0.070 $\lambda$ , 50.0 $\Omega$	12.19 x 1.37	0.480 x 0.054
$l_2$	0.122 $\lambda$ , 50.0 $\Omega$	20.93 x 1.37	0.824 x 0.054
$l_3$	0.031 $\lambda$ , 50.0 $\Omega$	5.31 x 1.37	0.209 x 0.054
$l_4$	0.063 $\lambda$ , 7.5 $\Omega$	9.58 x 16.21	0.377 x 0.638
$l_5$	0.162 $\lambda$ , 67.0 $\Omega$	28.45 x 0.79	1.120 x 0.031
$l_6, l_7$	0.150 $\lambda$ , 55.0 $\Omega$	25.65 x 1.17	1.010 x 0.046
$l_8$	0.198 $\lambda$ , 11.1 $\Omega$	30.73 x 10.46	1.210 x 0.412
$l_9$	0.145 $\lambda$ , 38.0 $\Omega$	24.21 x 2.16	0.953 x 0.085
$l_{10}$	0.009 $\lambda$ , 38.0 $\Omega$	1.52 x 2.16	0.060 x 0.085
$l_{11}$	0.026 $\lambda$ , 50.0 $\Omega$	4.50 x 1.37	0.177 x 0.054

<sup>1</sup>Electrical characteristics are rounded.

Reference Circuit (cont.)



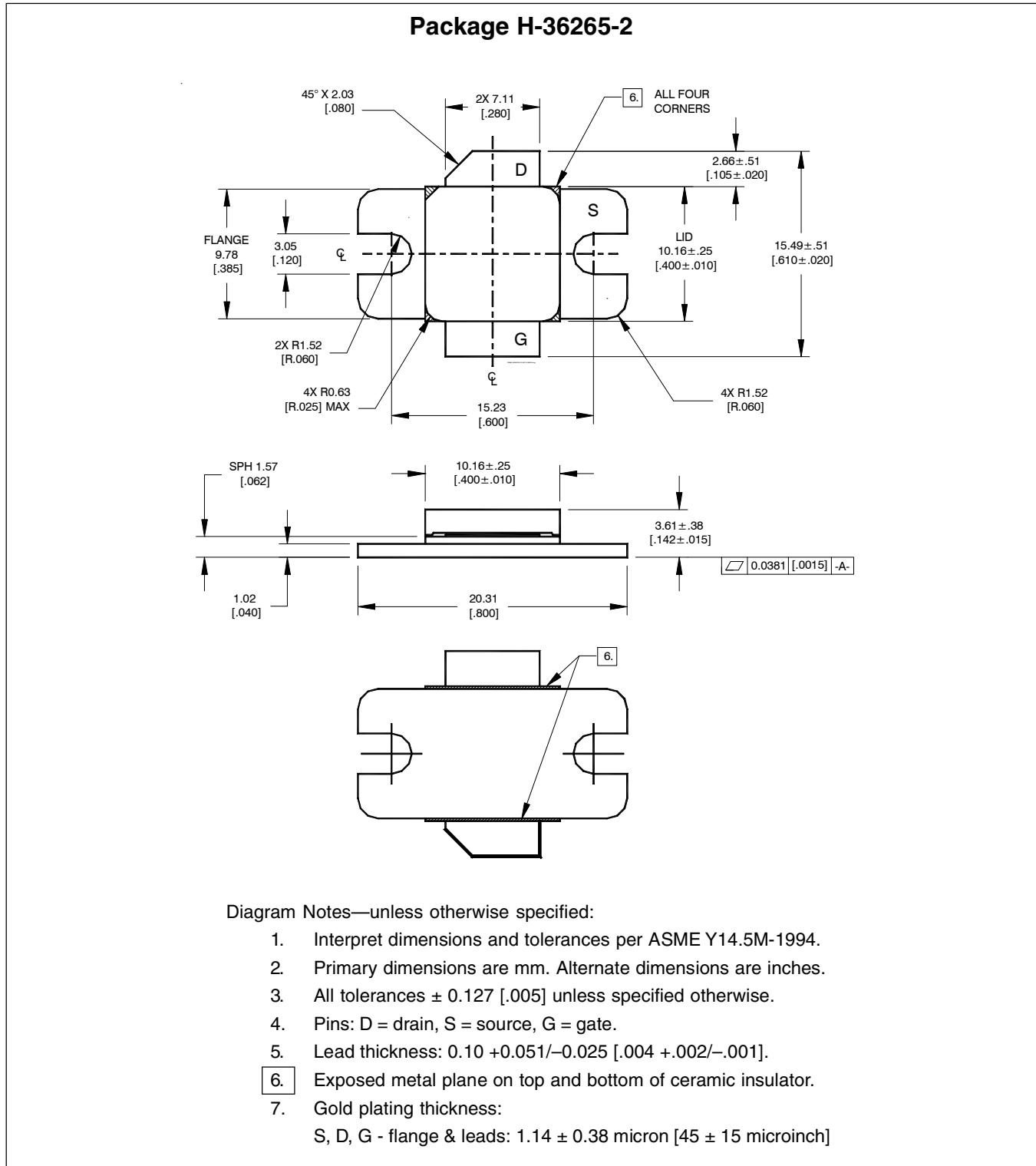
Reference circuit assembly diagram (not to scale)\*

Component	Description	Suggested Manufacturer	P/N or Comment
C1, C2, C3	Capacitor, 0.001 $\mu$ F	Digi-Key	PCC1772CT-ND
C4	Tantalum capacitor, 10 $\mu$ F, 35 V	Digi-Key	399-1655-2-ND
C5, C6, C15, C20	Capacitor, 0.1 $\mu$ F	Digi-Key	PCC104BCT-ND
C8, C9, C12, C17, C23	Ceramic capacitor, 33 pF	ATC	100B 330
C7	Capacitor, 0.01 $\mu$ F	ATC	200B 103
C10	Ceramic capacitor, 3.3 pF	ATC	100B 3R3
C11	Ceramic capacitor, 1.0 pF	ATC	100B 1R0
C13, C18	Capacitor, 1.0 $\mu$ F	ATC	920C105
C14, C16, C19, C21	Tantalum capacitor, 10 $\mu$ F, 50 V	Garrett Electronics	TPSE106K050R0400
C22	Ceramic capacitor, 0.3 pF	ATC	100B 0R3
L1, L2	Ferrite, 8.9 mm	Elna Magnetics	BDS 4.6/3/8.9-4S2
Q1	Transistor	Infineon Technologies	BCP56
QQ1	Voltage regulator	National Semiconductor	LM7805
R1	Chip Resistor 1.2 k-ohms	Digi-Key	P1.2KGCT-ND
R2	Chip Resistor 1.3 k-ohms	Digi-Key	P1.3KGCT-ND
R3	Chip Resistor 2 k-ohms	Digi-Key	P2KECT-ND
R4	Potentiometer 2 k-ohms	Digi-Key	3224W-202ETR-ND
R5, R7	Chip Resistor 5.1 k-ohms	Digi-Key	P5.1KECT-ND
R6, R8	Chip Resistor 10 ohms	Digi-Key	P10ECT-ND

\*Gerber Files for this circuit available on request

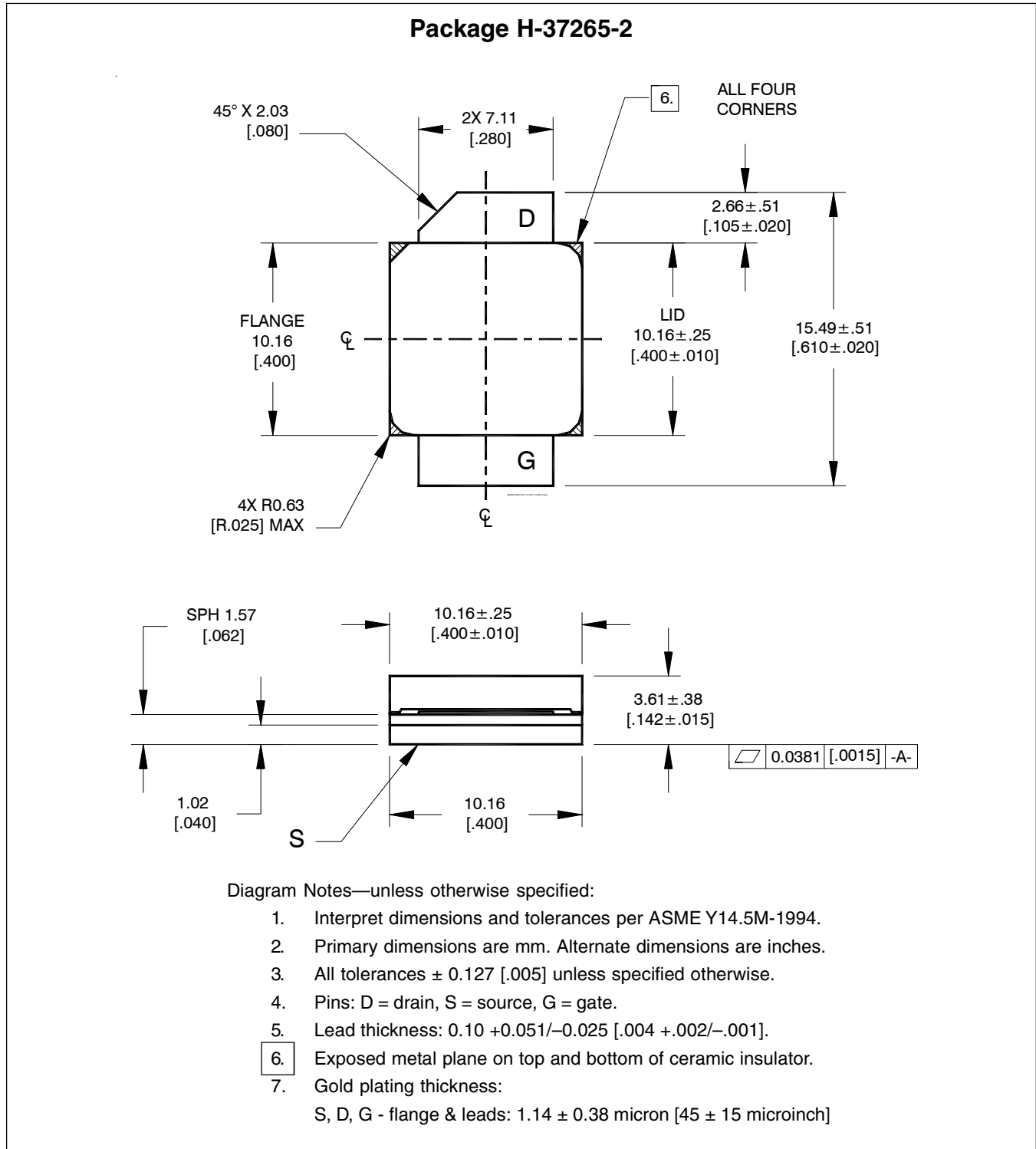
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Package Outline Specifications



Confidential, Limited Internal Distribution

Package Outline Specifications (cont.)



<b>Revision History:</b>	<b>2016-06-16</b>	Data Sheet
Previous Version:	2009-03-31, Data Sheet	
Page	Subjects (major changes since last revision)	
2	Update ordering information	

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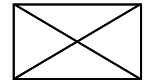
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